PD - 95198

International **TGR** Rectifier

IRFP440PbF

 $V_{DSS} = 500V$

 $R_{DS(on)} = 0.85\Omega$

D

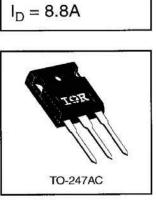
HEXFET[®] Power MOSFET

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.



Absolute Maximum Ratings

	Parameter	Max.	Units	
I _D @ T _C = 25°C	C = 25°C Continuous Drain Current, VGS @ 10 V 8.8			
Ip @ Tc = 100°C	Continuous Drain Current, VGS @ 10 V	5.6	A	
Іом	Pulsed Drain Current ①	35		
P _D @ T _C = 25°C	Power Dissipation	150	W	
	Linear Derating Factor	1.2	W/°C	
Vgs	Gate-to-Source Voltage	±20	V	
EAS	Single Pulse Avalanche Energy @	480	mJ	
IAR	Avalanche Current ①	8.8	A	
EAR	Repetitive Avalanche Energy ①	15	mJ	
dv/dt	Peak Diode Recovery dv/dt ③	3.5	V/ns	
Tj Tstg	Operating Junction and Storage Temperature Range	-55 to +150	°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1 N•m)		

Thermal Resistance

	Parameter	Min.	Тур.	Max.	Units	
Rejc	Junction-to-Case	10 	_	0.83		
Recs	Case-to-Sink, Flat, Greased Surface		0.24	—	°C/W	
Reja	Junction-to-Ambient		2	40		

International **TOR** Rectifier

	Parameter	Min.	Typ.	Max.	Units	Test Conditions	
V(BR)DSS	Drain-to-Source Breakdown Voltage	500	<u> </u>		V	V _{GS} =0V, I _D = 250μA	
ΔV(BR)DSS/ΔTJ	Breakdown Voltage Temp. Coefficient		0.78	<u></u> 0	V/°C	Reference to 25°C, ID= 1mA	
RDS(on)	Static Drain-to-Source On-Resistance	1 <u>111</u> 1		0.85	Ω	V _{GS} =10V, I _D =5.3A ④	
VGS(th)	Gate Threshold Voltage	2.0	—	4.0	V	V _{DS} =V _{GS} , I _D = 250µA	
Ø fs	Forward Transconductance	5.3			S	V _{DS} =50V, I _D =5.3A ④	
IDSS	Drain-to-Source Leakage Current	-	-	25	μA	V _{DS} =500V, V _{GS} =0V	
		—	-	250		V _{DS} =400V, V _{GS} =0V, T _J =125°C	
i	Gate-to-Source Forward Leakage	-	-	100	nA	V _{GS} =20V	
IGSS	Gate-to-Source Reverse Leakage		=	-100		V _{GS} =-20V	
Qg	Total Gate Charge			63		ID=8.0A	
Qgs	Gate-to-Source Charge	-	_	11	nC	V _{DS} =400V	
Qgd	Gate-to-Drain ("Miller") Charge	_		30		V _{GS} =10V See Fig. 6 and 13 @	
td(on)	Turn-On Delay Time	-	14			V _{DD} =250V	
tr	Rise Time	—	23	—	ns	ID=8.0A	
t _{d(off)}	Turn-Off Delay Time	-	49]	R _G =9.1Ω	
tr	Fall Time		20			$R_D=31\Omega$ See Figure 10 @	
LD	Internal Drain Inductance	-	5.0		nH	Between lead, 6 mm (0.25in.)	
Ls	Internal Source Inductance	-	13			from package and center of die contact	
Ciss	Input Capacitance	-	1300			V _{GS} =0V	
Coss	Output Capacitance	-	310		pF	V _{DS} = 25V	
Crss	Reverse Transfer Capacitance	-	120			f=1.0MHz See Figure 5	

Electrical Characteristics @ TJ = 25°C (unless otherwise specified)

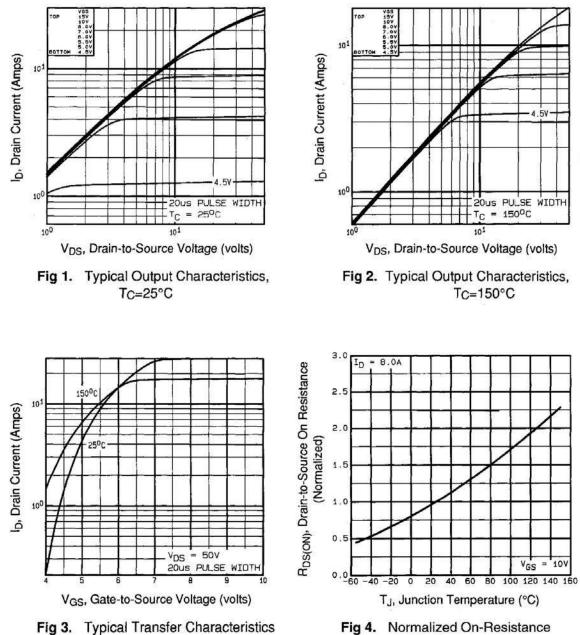
Source-Drain Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Test Conditions	
ls	Continuous Source Current (Body Diode)	-	-	8.8	Α	MOSFET symbol showing the	
ISM	Pulsed Source Current (Body Diode) ①	-	-	35		integral reverse	
VsD	Diode Forward Voltage			2.0	V	T_J=25°C, Is=8.8A, VGS=0V ④	
trr	Reverse Recovery Time		460	970	ns	Tյ=25°C, I⊧=8.0A di/dt=100A/μs ④	
Qrr	Reverse Recovery Charge	-	3.5	7.6	μC		
ton	Forward Turn-On Time	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+LD)					

Notes:

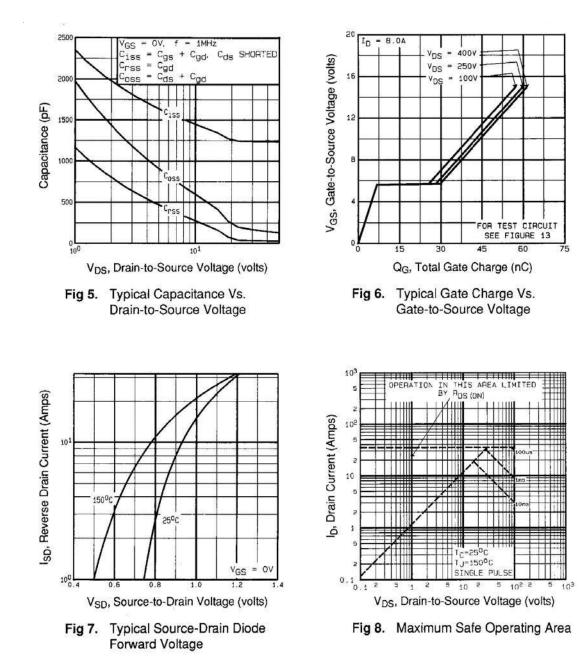
- Repetitive rating; pulse width limited by max. junction temperature (See Figure 11)
- ③ I_{SD}≤8.8A, di/dt≤100A/μs, V_{DD}≤V(_{BR)DSS}, T_J≤150°C
- ② V_{DD}=50V, starting T_J=25°C, L=11mH R_G=25Ω, I_{AS}=8.8A (See Figure 12)
- ④ Pulse width \leq 300 µs; duty cycle \leq 2%.

International **ISR** Rectifier



Vs. Temperature

International



Rp

VDD

D.U.T.

Vos)

International **tor** Rectifier

ID, Drain Current (Amps)

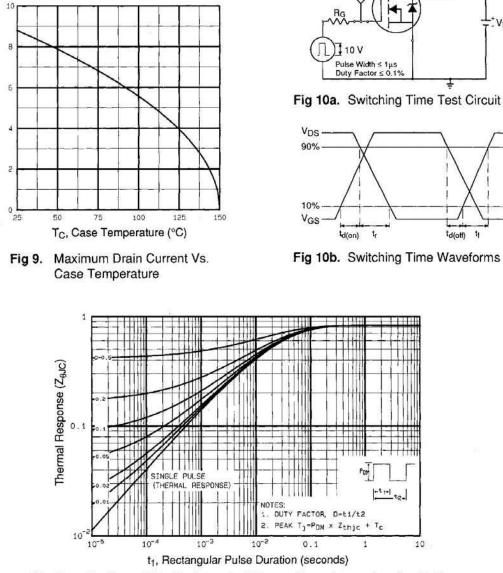


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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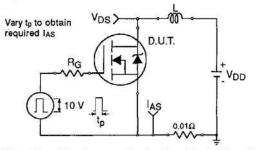


Fig 12a. Unclamped Inductive Test Circuit

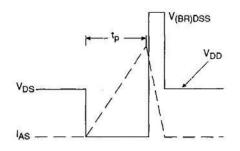


Fig 12b. Unclamped Inductive Waveforms

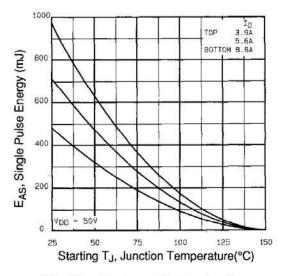


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

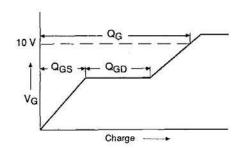


Fig 13a. Basic Gate Charge Waveform

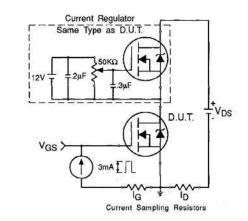


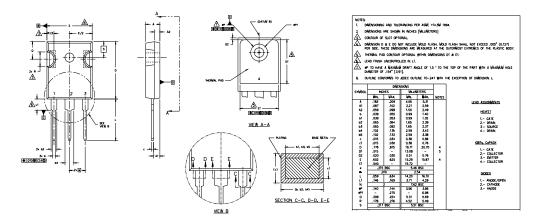
Fig 13b. Gate Charge Test Circuit

Appendix A: Figure 14, Peak Diode Recovery dv/dt Test Circuit - See page 1505

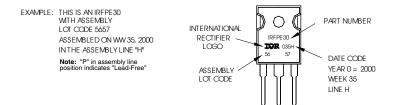
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TO-247AC Package Outline

Dimensions are shown in millimeters (inches)



TO-247AC Part Marking Information



Data and specifications subject to change without notice.

International

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105 TAC Fax: (310) 252-7903 04/04

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